

- Note:
- 1 Text element with square border.
 - 2 Text element with no border
 - 3 Text element with circle border
 - 4 Text element with no border
 - 5 Text element with no border
 - 6 Text element with no border
 - 7 Text element with no border

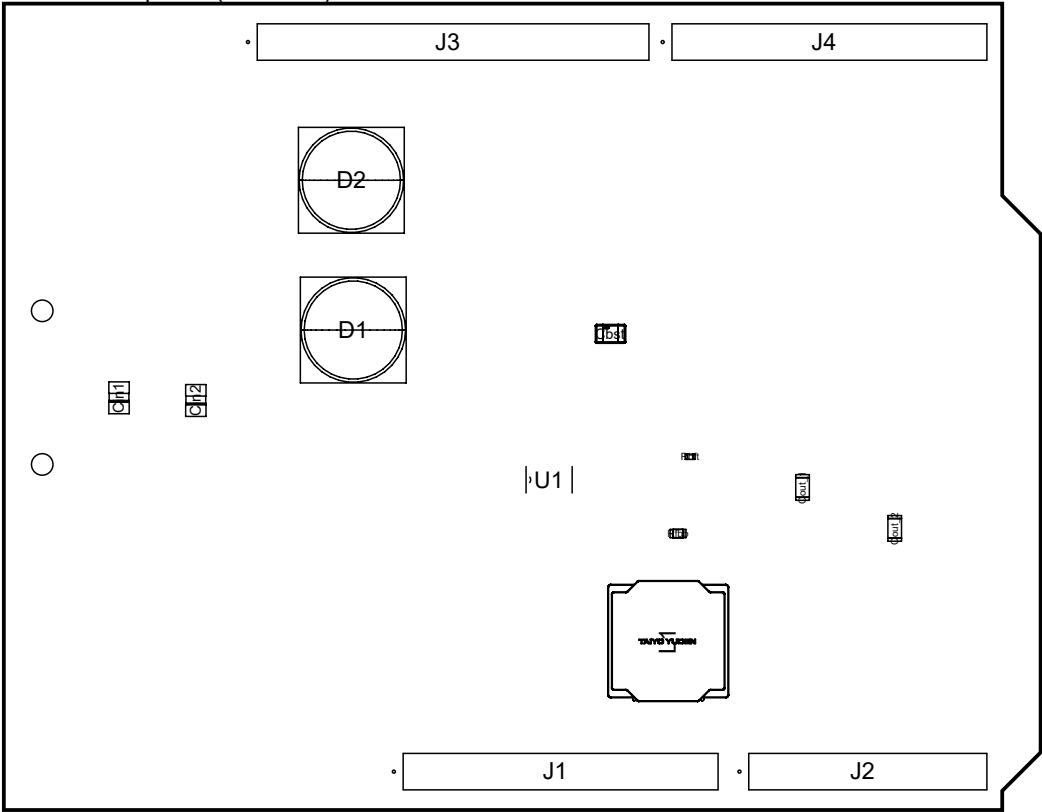
Layer Stack Legend						
	Material	Layer	Thickness	Dielectric Material	Type	Gerber
		Top Overlay			Legend	GTO
	Surface Material	Top Solder	0.01mm	Solder Resist	Solder Mask	GTS
	Copper	Top Layer	0.04mm		Signal	GTL
			1.52mm	FR-4	Dielectric	
	Copper	Bottom Layer	0.04mm		Signal	GBL
	Surface Material	Bottom Solder	0.01mm	Solder Resist	Solder Mask	GBS
		Bottom Overlay			Legend	GBO
Total thickness: 1.62mm						

Drill Table				
Symbol	Count	Hole Size	Plated	Hole Tolerance
○	2	1.52	Plated	
□	32	1.02	Plated	
✱	2	0.71	Plated	
⊕	3	0.51	Plated	+/-0.08
☆	5	0.51	Plated	
▽	14	0.25	Plated	

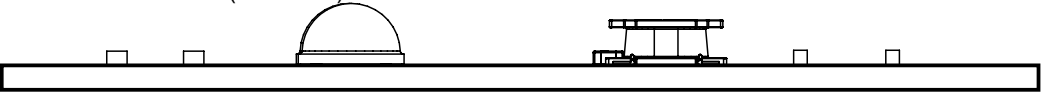
THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF Self-Practiced. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PROPRIETARY AND CONFIDENTIAL

		UNLESS OTHERWISE SPECIFIED:		NAME	DATE	Self-Practiced		
		DIMENSIONS ARE IN INCHES	DRAWN	Sam De	7/26/2025	Shield Board for Arduino Uno		
		TOLERANCES:	CHECKED					
		FRACTIONAL±	ENG APPR.					
		ANGULAR: MACH± BEND ±	MFG APPR.					
		TWO PLACE DECIMAL ±	Q.A.					
		THREE PLACE DECIMAL ±	COMMENTS:					
		INTERPRET GEOMETRIC TOLERANCING PER:						
		MATERIAL						
NEXT ASSY	USED ON	FINISH				SIZE	DWG. NO.	
APPLICATION		DO NOT SCALE DRAWING				SCALE: 2:1	WEIGHT:	SHEET 1 OF 3
						1		

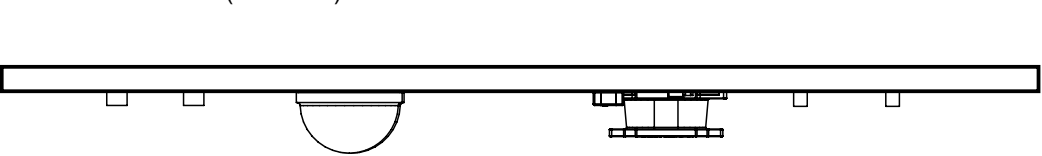
View from Top side (Scale 2:1)



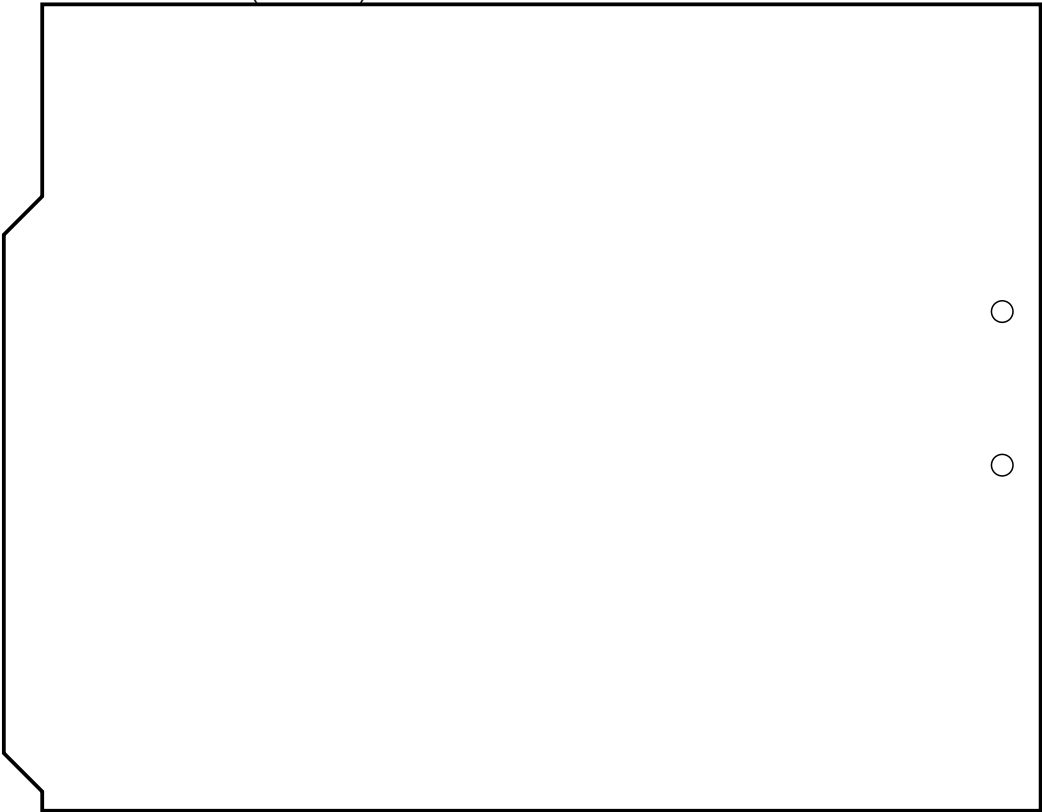
View from Front side (Scale 2:1)



View from Back side (Scale 2:1)



View from Bottom side (Scale 2:1)



ASSEMBLY NOTES

Board Name: Example Board

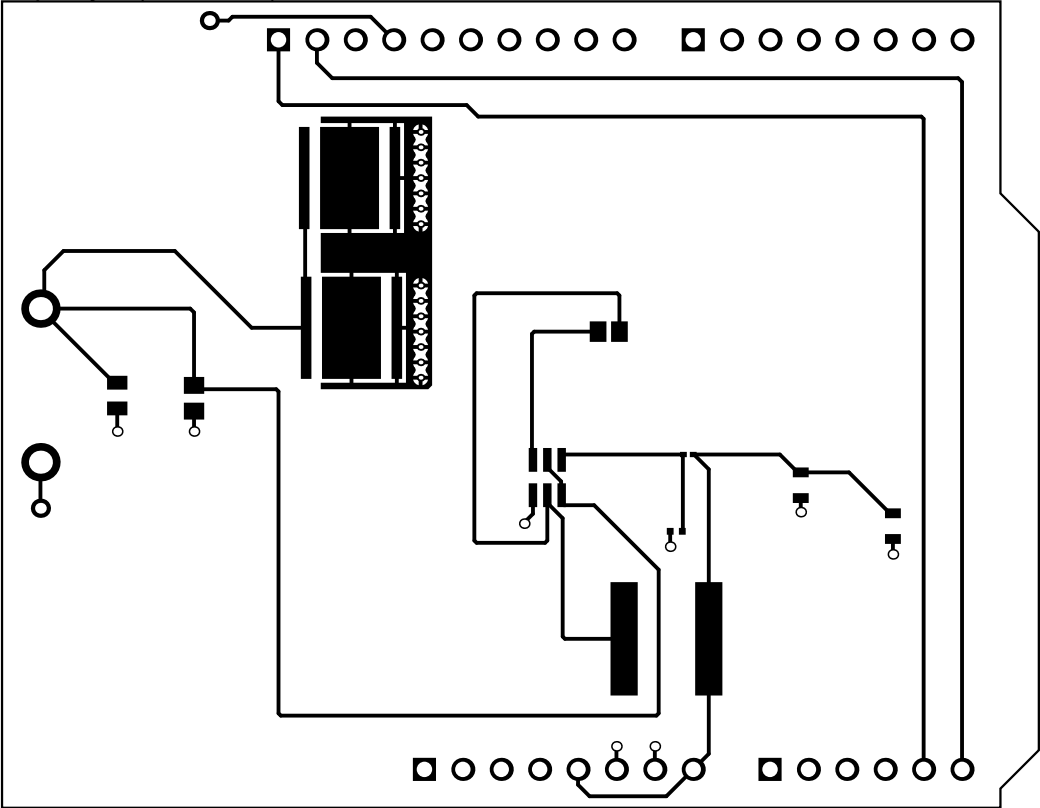
Rev: A

1. Assemble in accordance with IPC-A-610, current revision, Class 2.
2. Solder electrical connections per latest revision of IPC J-STD-001.
3. This assembly contains ESD sensitive components. Handle per ANSI/ESD S20.20.
4. RoHS compliance required: Yes.
5. Mark with current assembly revision.
6. Mount components with polarity and orientation as shown on component designators/silkscreen.

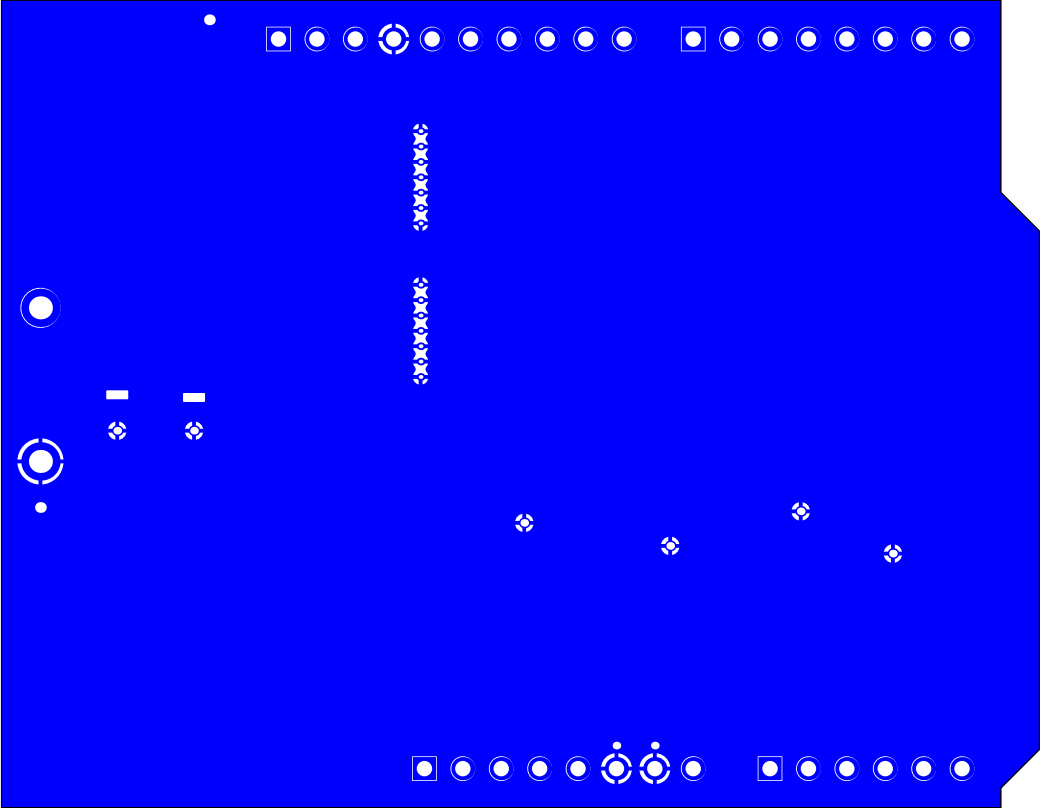
THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF Self-Practiced. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PROPRIETARY AND CONFIDENTIAL

		UNLESS OTHERWISE SPECIFIED:		NAME	DATE	Self-Practiced			
		DIMENSIONS ARE IN INCHES	DRAWN	Sam De	7/26/2025	Shield Board for Arduino Uno			
		TOLERANCES:	CHECKED						
		FRACTIONAL±	ENG APPR.						
		ANGULAR: MACH± BEND ±	MFG APPR.						
		TWO PLACE DECIMAL ±	Q.A.						
		THREE PLACE DECIMAL ±	COMMENTS:			1			
		INTERPRET GEOMETRIC TOLERANCING PER:							
		MATERIAL				SIZE	DWG. NO.		
NEXT ASSY	USED ON	FINISH							
APPLICATION		DO NOT SCALE DRAWING				SCALE:	2:1	WEIGHT:	SHEET 2 OF 3

Top Layer (Scale: 2:1)



Bottom Layer (Scale: 2:1)



NOTES: UNLESS OTHERWISE SPECIFIED.

- 1. FABRICATE PER IPC-6012A CLASS 2.
- 2. FOR BOARD THICKNESS AND IMPEDANCE DETAILS REFER STACKUP DOCUMENT.
- 3. PRINTED WIRING BOARD SHALL COMPLY WITH REQUIREMENTS OF ANSI/J-STD-003.
- 4. SURFACE FINISH: IMMERSION SILVER
- 5. SOLDERMASK ON BOTH SIDES OF THE BOARD SHALL BE LPI, COLOR XXXXXX.
- 6. SILK SCREEN LEGEND TO BE APPLIED PER LAYER STACKUP USING WHITE NON-CONDUCTIVE EPOXY INK.
- 7. THIS PRINTED WIRING BOARD IS DESIGNED WITH A MINIMUM CONDUCTOR WIDTH AND SPACING OF 4 MIL & 4 MILS.
- 8. ALL VIAS ARE TENTED ON BOTH SIDES UNLESS SOLDERMASK OPENED IN GERBER.
- 9. ALL VIAS ON PAD SHOULD BE FILLED WITH NON CONDUCTIVE EPOXY AND SURFACE SHOULD BE FLAT. FLATNESS TOLERANCE FOR VIA ON PADS: +0.000 /- 0.001 INCHES ON BOTH SIDES. THE MANUFACTURER IS REQUESTED TO SIZE PER THEIR SOLDERMASK TOLERANCE.
- 10. SOLDER MASK OPENING IS KEPT SAME SIZE AS PAD (1:1) FOR ALL COMPONENTS
- 11. VENDOR SHOULD FOLLOW ROHS COMPLIANT PROCESS AND Pb FREE FOR MANUFACTURING
- 12. MANUFACTURER'S IDENTIFICATION, DATECODE LETTER SHALL BE SILKSCREENED ON SOLDER SIDE OF THE BOARD.
- 13. TRACE WIDTH SHOULD BE ACCURATELY ETCHED. MAX TOLERANCE +/- 1 MIL
- 14. ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED.
- 15. FLATNESS REQUIREMENTS:
 - A. BOW AND TWIST OF ASSEMBLY SUB-PANEL OR SINGULATED PWB SHALL NOT EXCEED 0.7% OF LONGEST SIDE
 - B. TEST IN ACCORDANCE WITH THE CURRENT REVISION OF IPC-TM-650 2.4.22
- 16. PCB MATERIAL REQUIREMENTS:
 - A. FLAMMABILITY RATING MUST MEET OR EXCEED UL94V-0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 REGISTERED MATERIAL ID NUMBER.

THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF Self-Practiced. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PROPRIETARY AND CONFIDENTIAL

		UNLESS OTHERWISE SPECIFIED:		NAME	DATE	Self-Practiced		
		DIMENSIONS ARE IN INCHES	DRAWN	Scm De	7/26/2025	Shield Board for Arduino Uno		
		TOLERANCES:	CHECKED					
		FRACTIONAL±	ENG APPR.					
		ANGULAR: MACH± BEND ±	MFG APPR.					
		TWO PLACE DECIMAL ±	COMMENTS:			TITLE		
		THREE PLACE DECIMAL ±						
		INTERPRET GEOMETRIC TOLERANCING PER:	Q.A.					
		MATERIAL				SIZE	DWG. NO.	
NEXT ASSY	USED ON	FINISH					1	
APPLICATION		DO NOT SCALE DRAWING				SCALE: 2:1	WEIGHT:	SHEET 3 OF 3